MA3X789 (MA789)

Silicon epitaxial planar type

For super high speed switching For small current rectification

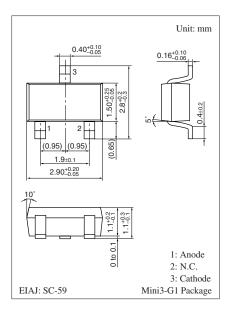
■ Features

- Forward current (Average) $I_{F(AV)} = 500$ mA rectification is possible
- Reverse voltage $V_R = 60 \text{ V}$ is guaranteed

■ Absolute Maximum Ratings $T_a = 25$ °C

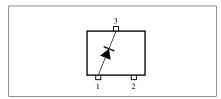
| Parameter | Symbol | Rating | Unit |
|---|--------------------|-------------|------|
| Reverse voltage | V_R | 60 | V |
| Maximum peak reverse voltage | V_{RM} | 60 | V |
| Forward current (Average) | I _{F(AV)} | 500 | mA |
| Non-repetitive peak forward surge current * | I _{FSM} | 2 | A |
| Junction temperature | T _j | 125 | °C |
| Storage temperature | T _{stg} | -55 to +125 | °C |

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)



Marking Symbol: M3W

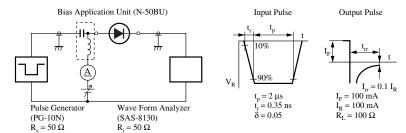
Internal Connection



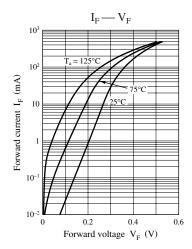
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

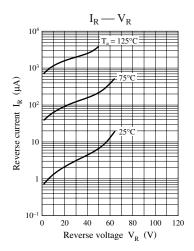
| Parameter | Symbol | Conditions | Min | Тур | Max | Unit |
|-------------------------|-----------------|--|-----|-----|------|------|
| Forward voltage | V_F | $I_F = 500 \text{ mA}$ | | | 0.65 | V |
| Reverse current | I_R | $V_R = 50 \text{ V}$ | | | 100 | μΑ |
| Terminal capacitance | C _t | $V_R = 0 V, f = 1 MHz$ | | 60 | | pF |
| Reverse recovery time * | t _{rr} | $I_F = I_R = 100 \text{ mA}$ | | 4.5 | | ns |
| | | $I_{rr} = 0.1 I_{R}, R_{L} = 100 \Omega$ | | | | |

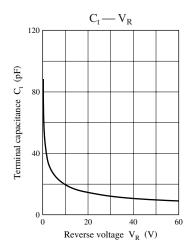
- $Note) \ 1. \ Measuring \ methods \ are \ based \ on \ JAPANESE \ INDUSTRIAL \ STANDARD \ JIS \ C \ 7031 \ measuring \ methods \ for \ diodes.$
 - This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 100 MHz.
- 4. *: t_{rr} measurement circuit

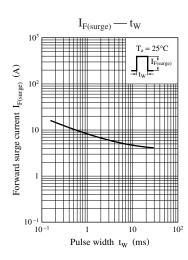


Note) The part number in the parenthesis shows conventional part number.









2 SKH00089CED

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